

SED30P30M

**P-Channel Enhancement-Mode MOSFET**

Revision: A

**General Description**

Advanced trench technology to provide excellent RDS(ON), low gate charge and low operation voltage. This device is suitable for using as a load switch or in PWM applications.

- Simple Drive Requirement
- Small Package Outline
- Surface Mount Device

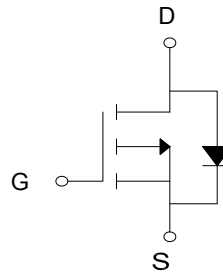
**Features**

For a single MOSFET

- $V_{DS} = -30V$
- $R_{DS(ON)} = 8.5m\Omega @ V_{GS}=-10V$

**Pin configurations**

See Diagram below



**Absolute Maximum Ratings**

Parameter	Symbol	Rating	Units
Drain-Source Voltage	$V_{DS}$	-30	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Drain Current	Continuous	-30	A
	Pulsed	-85	
Total Power Dissipation	@TA=25°C	2.1	W
Operating Junction Temperature Range	$T_J$	-55 to 150	°C

## SED30P30M

Electrical Characteristics (T <sub>J</sub> =25°C unless otherwise noted)						
Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
<b>OFF CHARACTERISTICS (Note 2)</b>						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	I <sub>D</sub> =-250μA, V <sub>GS</sub> =0 V	-30	-33		V
I <sub>DSS</sub>	Drain to Source Leakage Current	V <sub>DS</sub> = -30V, V <sub>GS</sub> =0V			-1	μA
I <sub>GSS</sub>	Gate-Body Leakage Current	V <sub>GS</sub> = 20V			100	nA
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> =-250μA	-1.3	-1.4	-1.5	V
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> =-10V, I <sub>D</sub> =-10A	-	8.5	11	mΩ
<b>DYNAMIC PARAMETERS</b>						
C <sub>iss</sub>	Input Capacitance	V <sub>GS</sub> =0V, V <sub>DS</sub> =-15V, f=1MHz		5270		pF
C <sub>oss</sub>	Output Capacitance			945		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			745		pF
<b>SWITCHING PARAMETERS</b>						
Q <sub>g</sub>	Total Gate Charge <sup>2</sup>	V <sub>GS</sub> =-10V, V <sub>DS</sub> =-15V, I <sub>D</sub> =-15A		100		nC
Q <sub>gs</sub>	Gate Source Charge			14.5		nC
Q <sub>gd</sub>	Gate Drain Charge			23		nC
t <sub>d(on)</sub>	Turn-On Delay Time	V <sub>GS</sub> =-10V, V <sub>DS</sub> =-15V, R <sub>GEN</sub> =3Ω, R <sub>L</sub> =1Ω		14		ns
t <sub>d(off)</sub>	Turn-Off Delay Time			76.5		ns
t <sub>d(r)</sub>	Turn-On Rise Time			16.5		ns
t <sub>d(f)</sub>	Turn-Off Fall Time			37.5		ns
<b>Thermal Resistance</b>						
Symbol	Parameter		Typ	Max	Units	
R <sub>θJA</sub>	Junction to Ambient (t ≦ 10s)		26	40	°C/W	

Typical Characteristics

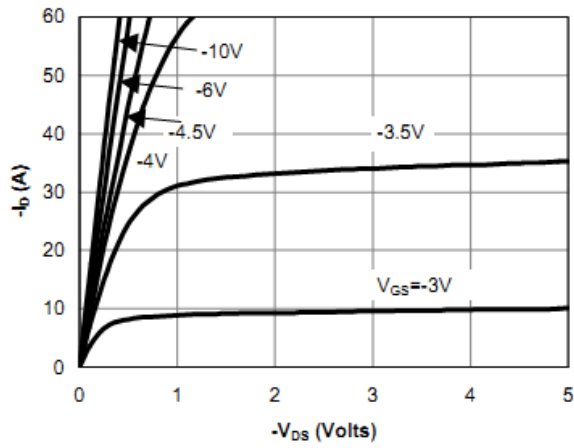


Fig 1: On-Region Characteristics

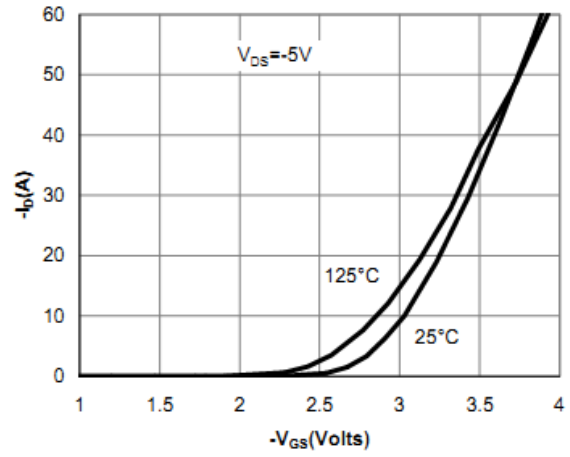


Figure 2: Transfer Characteristics

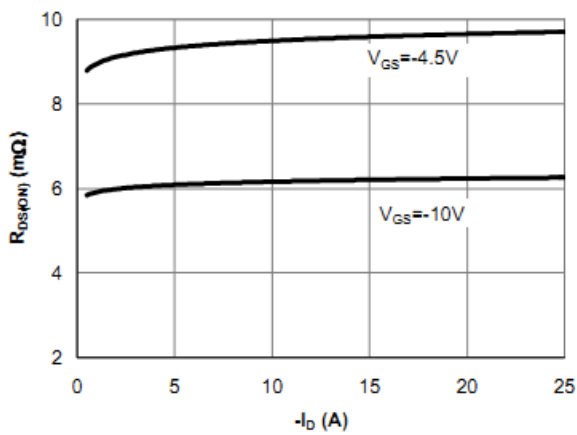


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

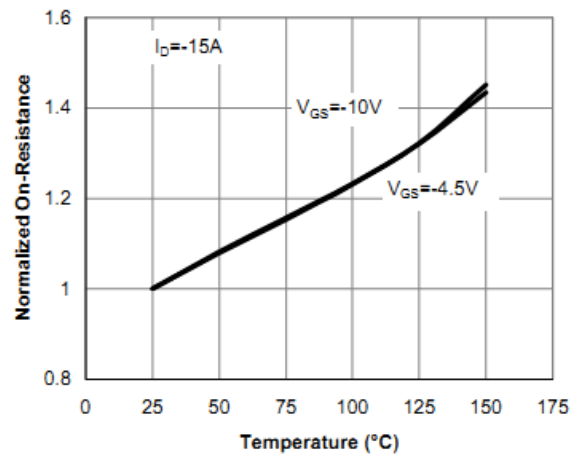


Figure 4: On-Resistance vs. Junction Temperature

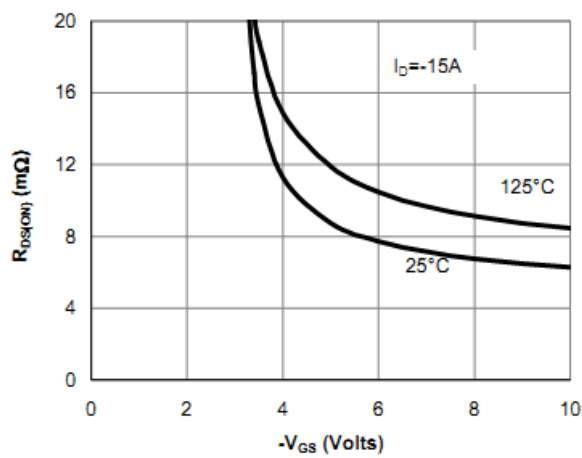


Figure 5: On-Resistance vs. Gate-Source Voltage

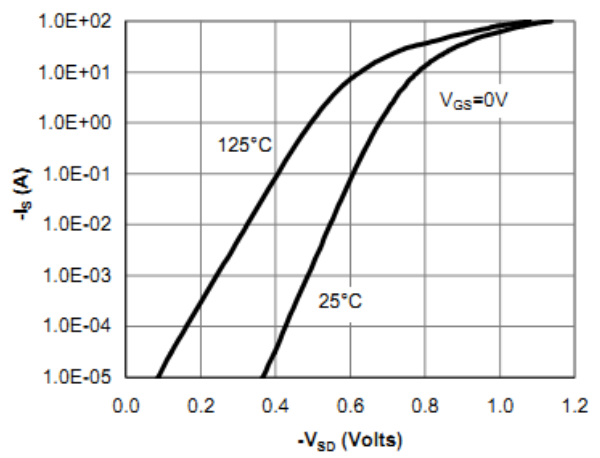


Figure 6: Body-Diode Characteristics

Typical Characteristics

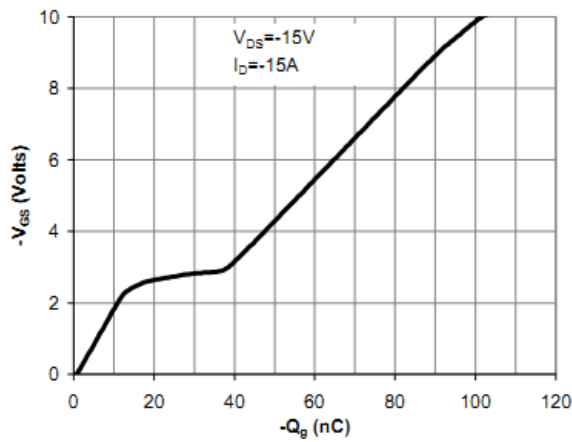


Figure 7: Gate-Charge Characteristics

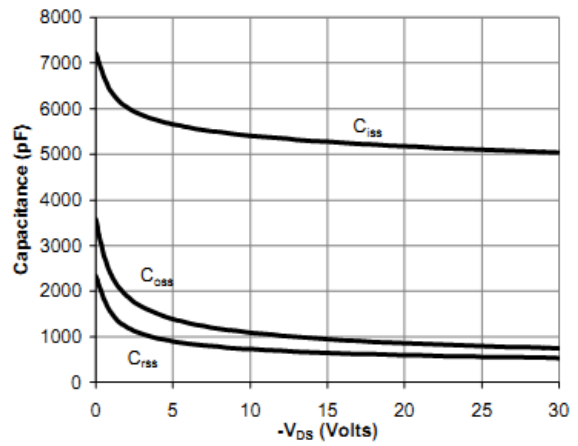


Figure 8: Capacitance Characteristics

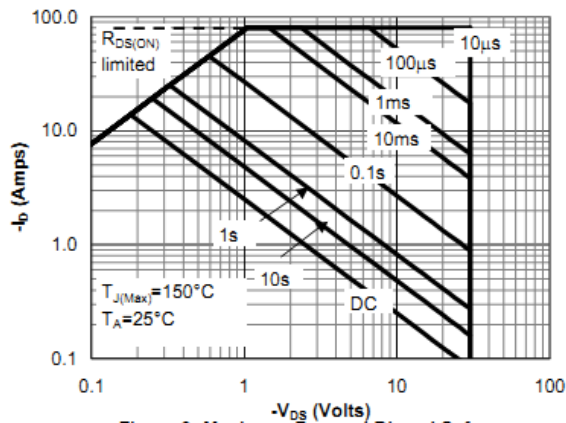


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

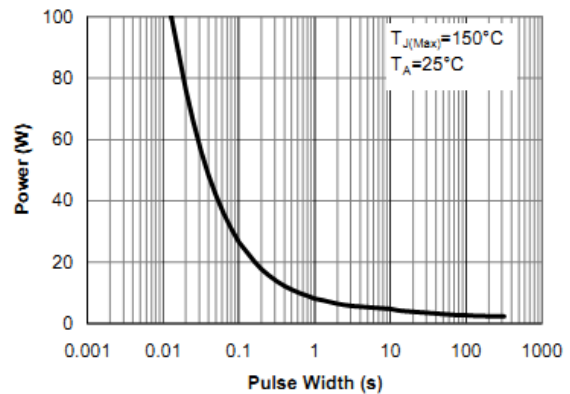


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

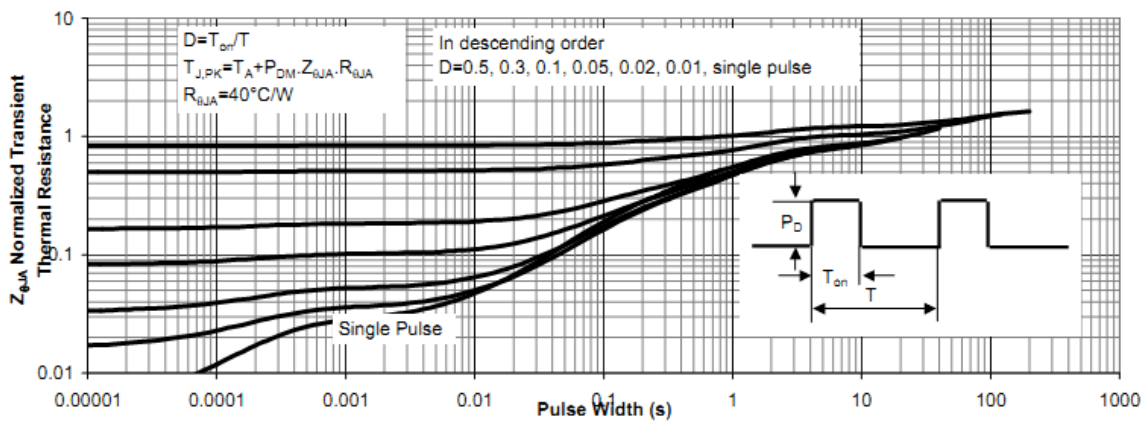
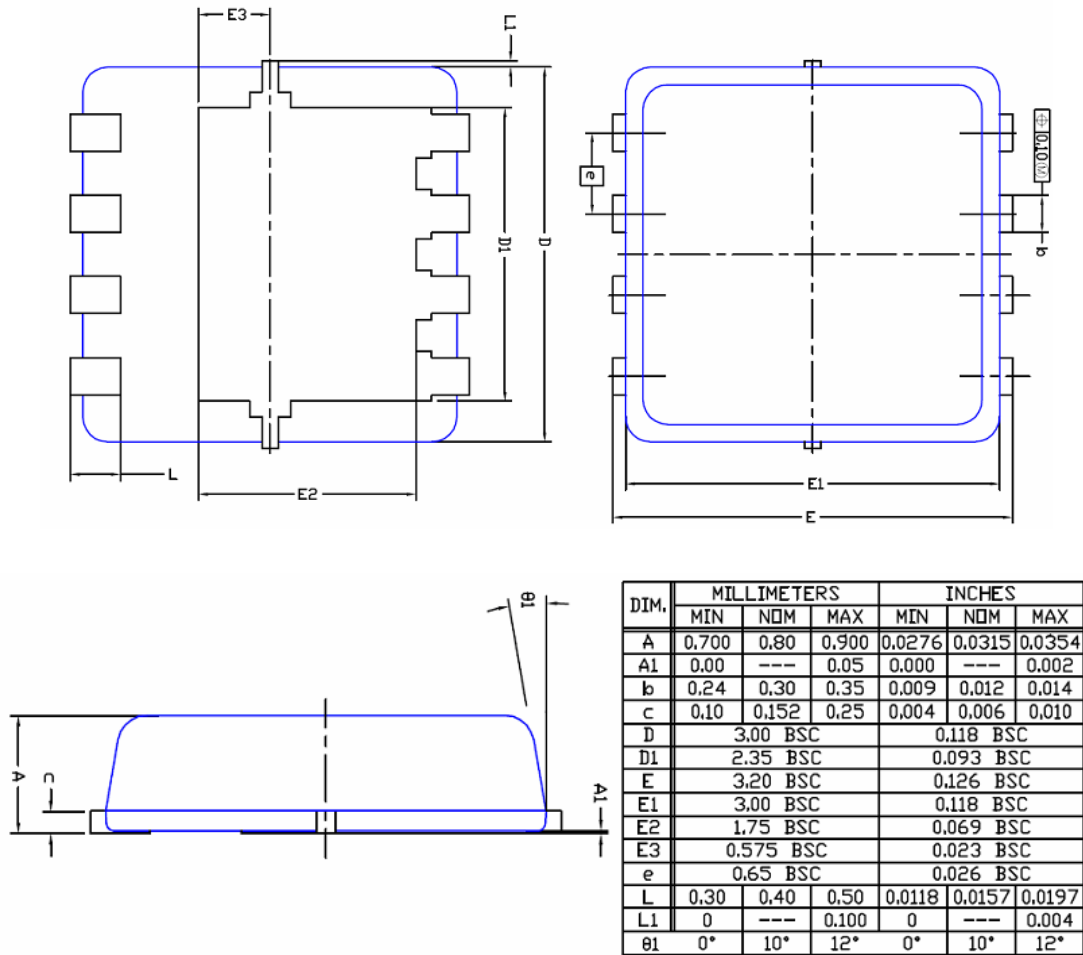


Figure 11: Normalized Maximum Transient Thermal Impedance

# SED30P30M

## Package Outline Dimension

### DFN3X3



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